



Lehighton Electronics, Inc.



NON-DESTRUCTIVE MOBILITY for Product Wafers

The LEI Model 1600 Measures

- Carrier Mobility (up to 20,000 $\text{cm}^2/\text{V-s}$)
- Sheet Charge Density ($1\text{E}10$ - $1\text{E}14$ carriers/ cm^2)
- Sheet Resistance (100 - $3,000$ Ω/\square)

Sold to NTT Advanced Technology Corp.
for InP-based electronic devices

In service at HRL Laboratories, LLC (CA)
Nippon Institute of Technology (Japan)

**Stop wasting \$\$\$ on Hall wafers
and lost reactor time!**

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